

MegaMOS™ FRED

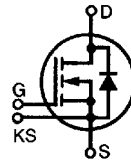
IXTN36N50

$$V_{DSS} = 500 \text{ V}$$

$$I_{D25} = 36 \text{ A}$$

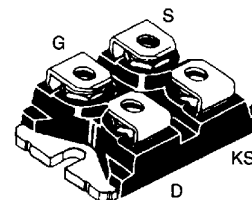
$$R_{DS(on)} = 0.12 \text{ } \Omega$$

N-Channel Enhancement Mode



| Symbol | Test Conditions | Maximum Ratings |
|---------------|---|--------------------------------------|
| V_{DSS} | $T_J = 25^\circ\text{C}$ to 150°C | 500 V |
| V_{DGR} | $T_J = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 10 \text{ k}\Omega$ | 500 V |
| V_{GS} | Continuous | ± 20 V |
| V_{GSM} | Transient | ± 30 V |
| I_{D25} | $T_C = 25^\circ\text{C}$ | 36 A |
| I_{DM} | $T_C = 25^\circ\text{C}$, pulse width limited by T_{JM} | 133 A |
| P_D | $T_C = 25^\circ\text{C}$ | 400 W |
| T_J | | -40 ... +150 $^\circ\text{C}$ |
| T_{JM} | | 150 $^\circ\text{C}$ |
| T_{stg} | | -40 ... +150 $^\circ\text{C}$ |
| V_{ISOL} | 50/60 Hz $t = 1 \text{ min}$ $I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$ | 2500 V~ 3000 V~ |
| M_d | Mounting torque Terminal connection torque (M4) | 1.5/13 Nm/lb.in. 1.5/13 Nm/lb.in. |
| Weight | | 30 g |

miniBLOC, SOT-227 B



G = Gate, D = Drain,
S = Source, KS = Kelvin Source

Features

- International standard package miniBLOC (ISOTOP compatible)
- Isolation voltage 3000 V~
- Low $R_{DS(on)}$ HDMOS™ process
- Rugged polysilicon gate cell structure
- Low drain-to-case capacitance (< 50 pF)
- Low package inductance (< 10 nH) - easy to drive and to protect

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|--------------|---|---|------|---------------------------|
| | | min. | typ. | max. |
| V_{DSS} | $V_{GS} = 0 \text{ V}$, $I_D = 1 \text{ mA}$ | 500 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 20 \text{ mA}$ | 2 | | V |
| I_{GSS} | $V_{GS} = \pm 20 V_{DC}$, $V_{DS} = 0$ | | | ± 500 nA |
| I_{DSS} | $V_{DS} = 0.8 \cdot V_{DSS}$ $V_{GS} = 0 \text{ V}$ | | | 400 μA 2 mA |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$, $I_D = 0.5 \cdot I_{D25}$ Pulse test, $t \leq 300 \text{ } \mu\text{s}$, duty cycle $d \leq 2 \%$ | | | 0.12 Ω |

Applications

- AC motor speed control
- DC servo and robot drives
- Uninterruptible power systems (UPS)
- Switch-mode and resonant-mode power supplies
- DC choppers

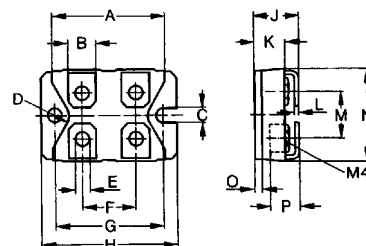
Advantages

- Easy to mount with 2 screws
- Space savings
- High power density

| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|--------------|---|---|------|--------|
| | | min. | typ. | max. |
| g_{fs} | $V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$, pulsed | 30 | 38 | S |
| C_{iss} | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | | 8.5 | nF |
| C_{oss} | | | 0.9 | nF |
| C_{rss} | | | 0.3 | nF |
| $t_{d(on)}$ | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$ $R_G = 1\ \Omega$, (External) | | | 100 ns |
| t_r | | | | 110 ns |
| $t_{d(off)}$ | | | | 220 ns |
| t_f | | | | 105 ns |
| $Q_{g(on)}$ | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 I_{D25}$ | | 270 | 350 nC |
| Q_{gs} | | | 60 | 90 nC |
| Q_{gd} | | | 125 | 200 nC |
| R_{thJC} | | | 0.31 | K/W |
| R_{thCK} | | 0.05 | | K/W |

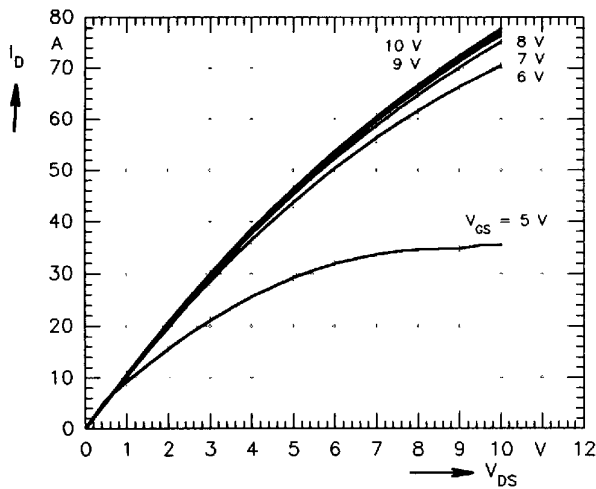
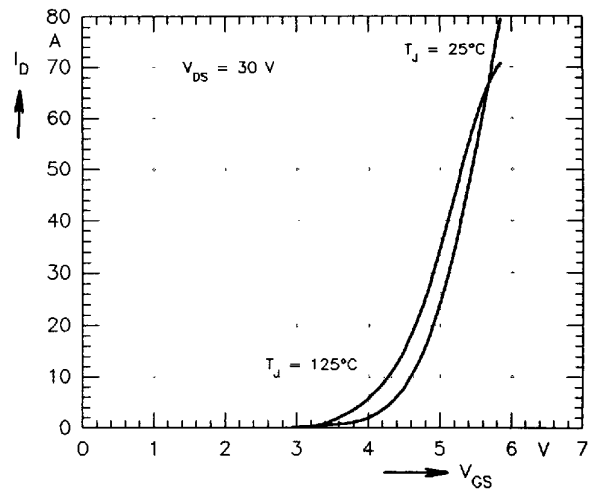
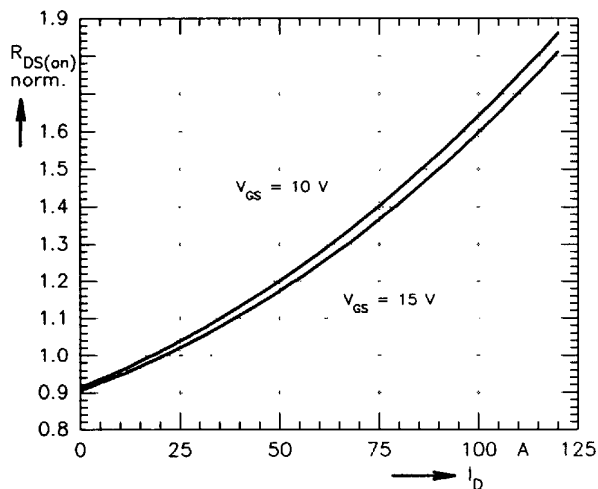
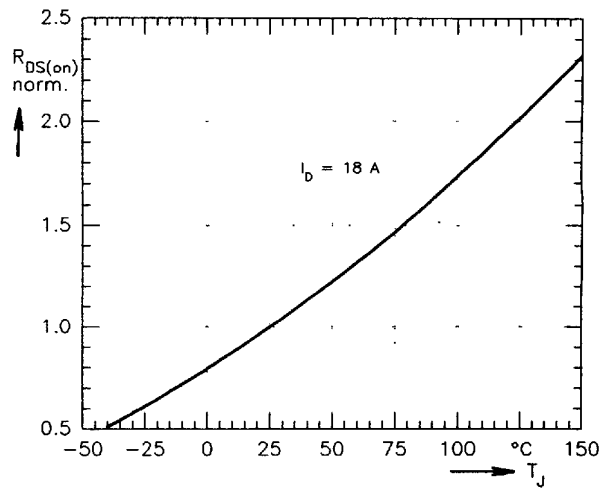
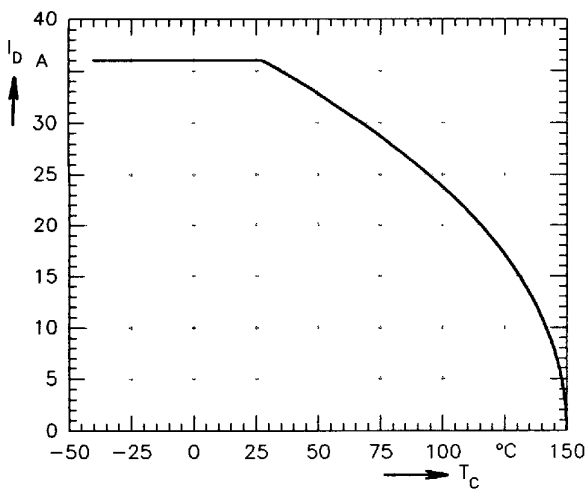
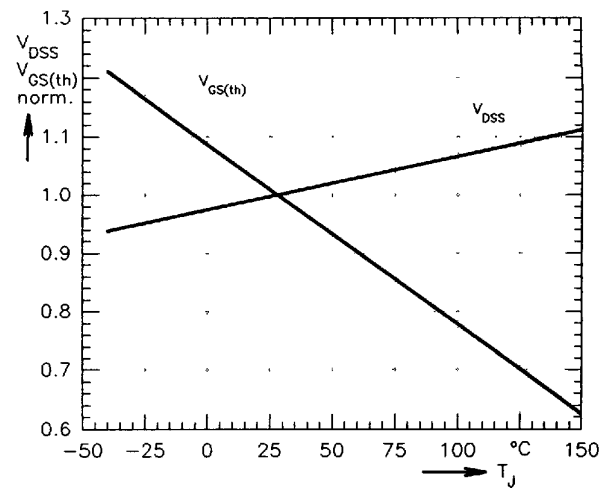
| Symbol | Test Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|----------|---|---|------|-------|
| | | min. | typ. | max. |
| I_S | $V_{GS} = 0$ | | | 36 A |
| I_{SM} | Repetitive; pulse width limited by T_{JM} | | | 144 A |
| V_{SD} | $I_F = I_S, V_{GS} = 0\text{ V}$, Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle $d \leq 2\%$ | | | 1.5 V |
| t_{tr} | $I_F = I_S, -di/dt = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$ | 600 | | ns |

miniBLOC, SOT 227-B



M4 screws (4x) supplied

| Dim. | Millimeter | | Inches | |
|------|------------|------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 31.5 | 31.7 | 1.241 | 1.249 |
| B | 7.8 | 8.2 | 0.307 | 0.323 |
| C | 4.0 | - | 0.158 | - |
| D | 4.1 | 4.3 | 0.162 | 0.169 |
| E | 4.1 | 4.3 | 0.162 | 0.169 |
| F | 14.9 | 15.1 | 0.587 | 0.595 |
| G | 30.1 | 30.3 | 1.186 | 1.193 |
| H | 38.0 | 38.2 | 1.497 | 1.505 |
| J | 11.8 | 12.2 | 0.465 | 0.481 |
| K | 8.9 | 9.1 | 0.351 | 0.359 |
| L | 0.75 | 0.85 | 0.030 | 0.033 |
| M | 12.6 | 12.6 | 0.496 | 0.504 |
| N | 25.2 | 25.4 | 0.993 | 1.001 |
| O | 1.95 | 2.05 | 0.077 | 0.081 |
| P | - | 5.0 | - | 0.197 |

Fig. 1 Typ output characteristics, $I_D = f(V_{DS})$ Fig. 2 Typ. transfer characteristics, $I_D = f(V_{GS})$ Fig. 3 Typ. normalized $R_{DS(on)} = f(I_D)$ Fig. 4 Typ. normalized $R_{DS(on)} = f(T_J)$ Fig. 5 Continuous drain current $I_D = f(T_C)$ Fig. 6 Typ. normalized $V_{DSS} = f(T_J)$, $V_{GS(th)} = f(T_J)$

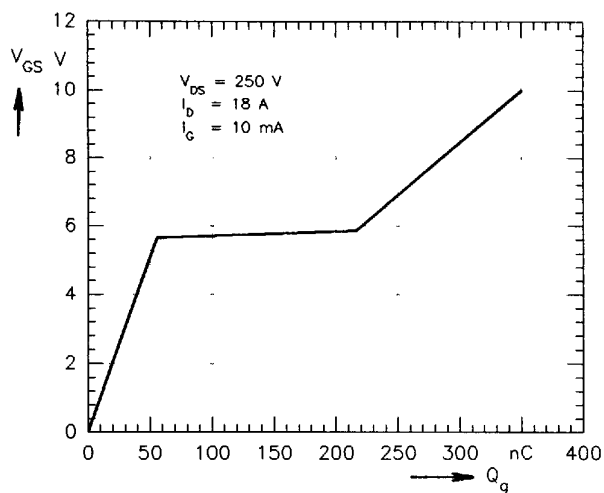


Fig. 7 Typ. turn-on gate charge characteristics,
 $V_{GS} = f(Q_g)$

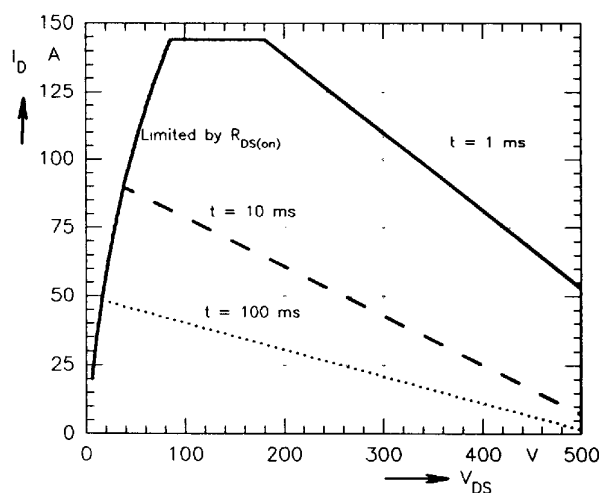


Fig. 8 Forward Bias Safe Operating Area $I_D = f(V_{DS})$

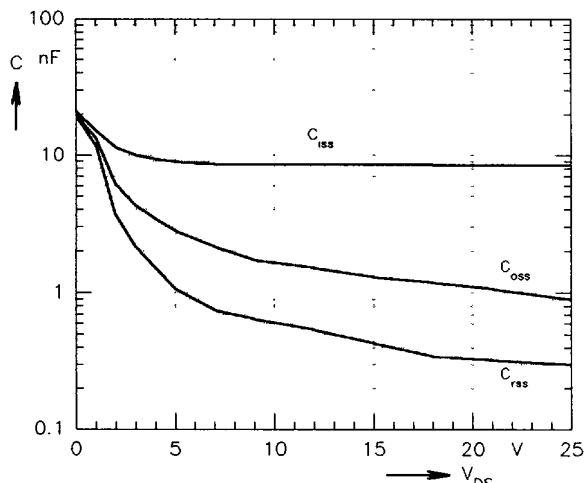


Fig. 9 Typ. capacitances $C = f(V_{DS})$, $f = 1 \text{ MHz}$

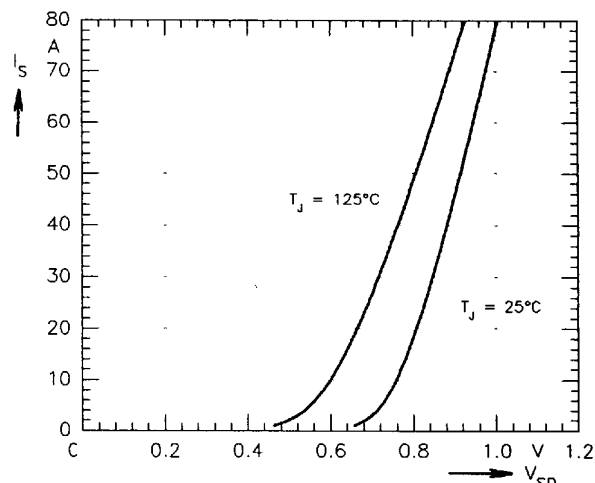


Fig. 10 Typ. forward characteristics of reverse diode
 $I_S = f(V_{SD})$

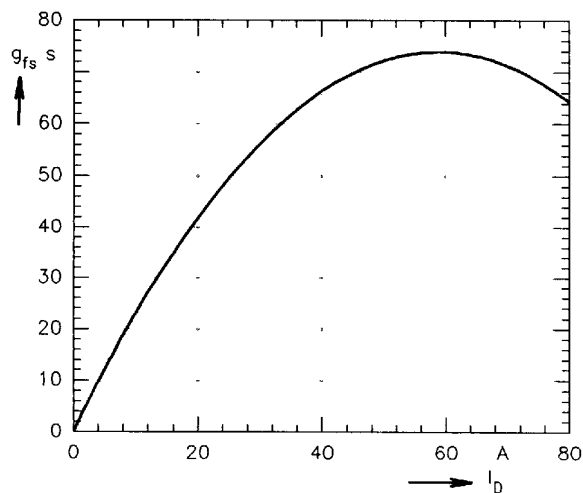


Fig. 11 Typ. transconductance, $g_{fs} = f(I_D)$

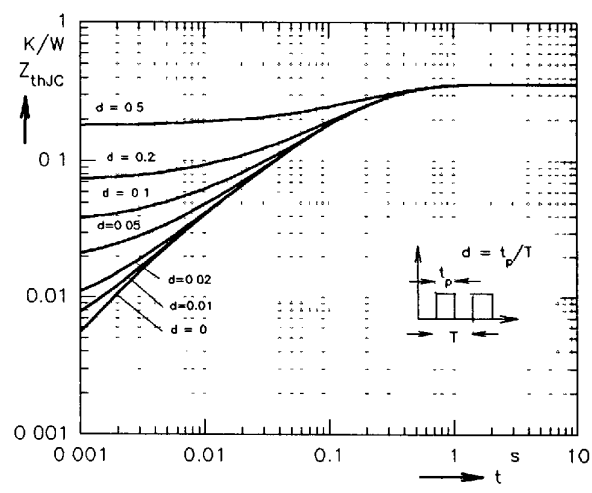


Fig. 12 Transient thermal resistance, $Z_{thJC} = f(t)$